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## MJE18008, MJF18008

## Switch-mode NPN Bipolar Power Transistor <br> For Switching Power Supply Applications

The MJE/MJF18008 have an applications specific state-of-the-art die designed for use in 220 V line-operated switch-mode Power supplies and electronic light ballasts.

## Features

- Improved Efficiency Due to Low Base Drive Requirements:
- High and Flat DC Current Gain $\mathrm{h}_{\mathrm{FE}}$
- Fast Switching
- No Coil Required in Base Circuit for Turn-Off (No Current Tail)
- Tight Parametric Distributions are Consistent Lot-to-Lot
- Two Package Choices: Standard TO-220 or Isolated TO-220
- MJF18008, Case 221D, is UL Recognized at 3500 V $_{\text {RMS }}$ : File \#E69369
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant*


## MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: |
| Collector-Emitter Sustaining Voltage | $\mathrm{V}_{\text {CEO }}$ | 450 | Vdc |
| Collector-Base Breakdown Voltage | $\mathrm{V}_{\text {CES }}$ | 1000 | Vdc |
| Emitter-Base Voltage | $\mathrm{V}_{\text {Ebo }}$ | 9.0 | Vdc |
| Collector Current - Continuous | $\mathrm{I}_{\mathrm{C}}$ | 8.0 | Adc |
| Collector Current - Peak (Note 1) | $\mathrm{I}_{\text {CM }}$ | 16 | Adc |
| Base Current - Continuous | $\mathrm{I}_{\mathrm{B}}$ | 4.0 | Adc |
| Base Current - Peak (Note 1) | IBM | 8.0 | Adc |
| RMS Isolation Voltage (Note 2) <br> Test No. 1 Per Figure 22a <br> Test No. 1 Per Figure 22b <br> Test No. 1 Per Figure 22c <br> (for 1 sec, R.H. $<30 \%, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ ) | VISOL | $\begin{gathered} \hline \text { MJF18008 } \\ 4500 \\ 3500 \\ 1500 \end{gathered}$ | V |
|  | $\mathrm{P}_{\mathrm{D}}$ | $\begin{gathered} 125 \\ 45 \\ 1.0 \\ 0.36 \end{gathered}$ | $\begin{gathered} \mathrm{W} \\ \mathrm{~W} /{ }^{\circ} \mathrm{C} \end{gathered}$ |
| Operating and Storage Temperature | $\mathrm{T}_{\mathrm{J}}, \mathrm{T}_{\text {stg }}$ | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

THERMAL CHARACTERISTICS

| Characteristics | Symbol | Max | Unit |
| :--- | :---: | :---: | :---: |
| Thermal Resistance, Junction-to-Case <br> MJE18008 <br> MJF18008 | $\mathrm{R}_{\text {өJC }}$ |  | 1.0 |
| 2.78 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |  |  |
| Thermal Resistance, Junction-to-Ambient | $\mathrm{R}_{\text {日JA }}$ | 62.5 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| Maximum Lead Temperature for Soldering <br> Purposes 1/8" from Case for 5 Seconds | $\mathrm{T}_{\mathrm{L}}$ | 260 | ${ }^{\circ} \mathrm{C}$ |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Pulse Test: Pulse Width $=5 \mathrm{~ms}$, Duty Cycle $\leq 10 \%$.
2. Proper strike and creepage distance must be provided.


## ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ELECTRICAL CHARACTERISTICS $\left(\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C}\right.$ unless otherwise specified)

| Characteristic | Symbol | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| OFF CHARACTERISTICS |  |  |  |  |  |
| Collector-Emitter Sustaining Voltage ( $\mathrm{I}_{\mathrm{C}}=100 \mathrm{~mA}, \mathrm{~L}=25 \mathrm{mH}$ ) | $\mathrm{V}_{\text {CEO(sus) }}$ | 450 | - | - | Vdc |
| Collector Cutoff Current ( $\mathrm{V}_{\mathrm{CE}}=$ Rated $\mathrm{V}_{\text {CEO }}, \mathrm{I}_{\mathrm{B}}=0$ ) | $I_{\text {CEO }}$ | - | - | 100 | $\mu \mathrm{Adc}$ |
| $\begin{array}{cl} \hline \text { Collector Cutoff Current }\left(\mathrm{V}_{\mathrm{CE}}=\text { Rated } \mathrm{V}_{\mathrm{CES}}, \mathrm{~V}_{\mathrm{EB}}=0\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ \left(\mathrm{V}_{\mathrm{CE}}=800 \mathrm{~V}, \mathrm{~V}_{\mathrm{EB}}=0\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \end{array}$ | $I_{\text {CES }}$ | - | - | $\begin{aligned} & 100 \\ & 500 \\ & 100 \\ & \hline \end{aligned}$ | $\mu \mathrm{Adc}$ |
| Emitter Cutoff Current ( $\mathrm{V}_{\mathrm{EB}}=9.0 \mathrm{Vdc}, \mathrm{I}_{\mathrm{C}}=0$ ) | $\mathrm{l}_{\text {EBO }}$ | - | - | 100 | $\mu \mathrm{Adc}$ |

## ON CHARACTERISTICS

| Base-Emitter Saturation Voltage ( $\mathrm{I}_{\mathrm{C}}=2.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.2 \mathrm{Adc}$ ) $\left(\mathrm{I}_{\mathrm{C}}=4.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.9 \mathrm{Adc}\right)$ | $\mathrm{V}_{\mathrm{BE} \text { (sat) }}$ | - | $\begin{aligned} & 0.82 \\ & 0.92 \end{aligned}$ | $\begin{gathered} 1.1 \\ 1.25 \end{gathered}$ | Vdc |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $\begin{array}{ll} \hline \begin{array}{l} \text { Collector-Emitter Saturation Voltage } \\ \left(I_{C}=2.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.2 \mathrm{Adc}\right) \end{array} & \\ \left(\mathrm{I}_{\mathrm{C}}=4.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B}}=0.9 \mathrm{Adc}\right) & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ & \left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right) \\ \hline \end{array}$ | $\mathrm{V}_{\mathrm{CE} \text { (sat) }}$ |  | $\begin{gathered} 0.3 \\ 0.3 \\ 0.35 \\ 0.4 \end{gathered}$ | $\begin{gathered} 0.6 \\ 0.65 \\ 0.7 \\ 0.8 \end{gathered}$ | Vdc |
| DC Current Gain ( $\mathrm{I}_{\mathrm{C}}=1.0 \mathrm{Adc}, \mathrm{V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}$ ) $\left(\mathrm{I}_{\mathrm{C}}=4.5 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=1.0 \mathrm{Vdc}\right)$ $\left(I_{C}=2.0 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CE}}=1.0 \mathrm{Vdc}\right)$ $\begin{aligned} & \left(T_{C}=125^{\circ} \mathrm{C}\right) \\ & \left(T_{C}=125^{\circ} \mathrm{C}\right) \\ & \left(T_{C}=125^{\circ} \mathrm{C}\right) \end{aligned}$ $\left(\mathrm{I}_{\mathrm{C}}=10 \mathrm{mAdc}, \mathrm{~V}_{\mathrm{CE}}=5.0 \mathrm{Vdc}\right)$ | $\mathrm{h}_{\text {FE }}$ | $\begin{gathered} 14 \\ - \\ 6.0 \\ 5.0 \\ 11 \\ 11 \\ 10 \end{gathered}$ | $\begin{aligned} & - \\ & 28 \\ & 9.0 \\ & 8.0 \\ & 15 \\ & 16 \\ & 20 \\ & \hline \end{aligned}$ | $34$ | - |

## DYNAMIC CHARACTERISTICS

| Current Gain Bandwidth ( $\mathrm{I}_{\mathrm{C}}=0.5 \mathrm{Adc}, \mathrm{V}_{\mathrm{CE}}=10 \mathrm{Vdc}, \mathrm{f}=1.0 \mathrm{MHz}$ ) |  |  |  | $\mathrm{f}_{\mathrm{T}}$ | - | 13 | - | MHz |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Capacitance ( $\mathrm{V}_{\mathrm{CB}}=10 \mathrm{Vdc}, \mathrm{I}_{\mathrm{E}}=0, \mathrm{f}=1.0 \mathrm{MHz}$ ) |  |  |  | $\mathrm{C}_{\text {ob }}$ | - | 100 | 150 | pF |
| Input Capacitance ( $\mathrm{V}_{\mathrm{EB}}=8.0 \mathrm{~V}$ ) |  |  |  | $\mathrm{C}_{\text {ib }}$ | - | 1750 | 2500 | pF |
| Dynamic Saturation Voltage: <br> Determined $1.0 \mu \mathrm{~s}$ and $3.0 \mu \mathrm{~s}$ respectively after rising $\mathrm{I}_{\mathrm{B} 1}$ reaches $90 \%$ of final $l_{B 1}$ (see Figure 18) | $\begin{gathered} \left(\mathrm{I}_{\mathrm{C}}=2.0 \mathrm{Adc}\right. \\ \mathrm{I}_{\mathrm{B} 1}=200 \mathrm{mAdc} \\ \left.\mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{gathered}$ | $1.0 \mu \mathrm{~S}$ | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{V}_{\text {CE(dsat) }}$ | - | $\begin{array}{r} \hline 5.5 \\ 11.5 \end{array}$ | - | Vdc |
|  |  | 3.0 us | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ |  | - | 3.5 6.5 | - |  |
|  | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=5.0 \mathrm{Adc}\right. \\ & \mathrm{I}_{\mathrm{B} 1}=1.0 \mathrm{Adc} \\ & \left.\mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | 1.0 us | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ |  | - | $\begin{aligned} & 11.5 \\ & 14.5 \end{aligned}$ | - |  |
|  |  | 3.0 us | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ |  | - | 2.4 9.0 | - |  |

SWITCHING CHARACTERISTICS: Resistive Load (D.C. $\leq 10 \%$, Pulse Width $=20 \mu \mathrm{~s}$ )

| Turn-On Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=2.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.2 \mathrm{Adc},\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=1.0 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $\begin{aligned} & \left(T_{C}=125^{\circ} \mathrm{C}\right) \\ & \left(T_{C}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{t}_{\text {on }}$ | - | 200 190 | 300 - | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Turn-Off Time |  |  | $\mathrm{t}_{\text {off }}$ | - | 1.2 1.5 | 2.5 <br> - | $\mu \mathrm{S}$ |
| Turn-On Time | $\begin{aligned} & \left(\mathrm{I}_{\mathrm{C}}=4.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.9 \mathrm{Adc},\right. \\ & \left.\mathrm{I}_{\mathrm{B} 2}=2.25 \mathrm{Adc}, \mathrm{~V}_{\mathrm{CC}}=300 \mathrm{~V}\right) \end{aligned}$ | $\begin{aligned} & \left(T_{C}=125^{\circ} \mathrm{C}\right) \\ & \left(T_{C}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{t}_{\text {on }}$ | - | $\begin{aligned} & \hline 100 \\ & 250 \end{aligned}$ | 180 - | ns |
| Turn-Off Time |  |  | $\mathrm{t}_{\text {off }}$ | - | 1.6 2.0 | 2.5 - | $\mu \mathrm{S}$ |

SWITCHING CHARACTERISTICS: Inductive Load (V ${ }_{\text {clamp }}=300 \mathrm{~V}, \mathrm{~V}_{\mathrm{CC}}=15 \mathrm{~V}, \mathrm{~L}=200 \mu \mathrm{H}$ )

| Fall Time | $\begin{gathered} \left(\mathrm{I}_{\mathrm{C}}=2.0 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.2 \mathrm{Adc},\right. \\ \left.\mathrm{I}_{\mathrm{B} 2}=1.0 \mathrm{Adc}\right) \end{gathered}$ | $\begin{aligned} & \left(T_{C}=125^{\circ} \mathrm{C}\right) \\ & \left(T_{C}=125^{\circ} \mathrm{C}\right) \end{aligned}$ | $\mathrm{t}_{\mathrm{fi}}$ | - | $\begin{aligned} & 100 \\ & 120 \end{aligned}$ | $180$ | ns |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Storage Time |  |  | $\mathrm{t}_{\mathrm{si}}$ | - | 1.5 1.9 | 2.75 - | $\mu \mathrm{S}$ |
| Crossover Time |  | $\left(T_{C}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{c}}$ | - | $\begin{aligned} & 250 \\ & 230 \end{aligned}$ | 350 <br> - | ns |
| Fall Time | $\begin{gathered} \left(\mathrm{I}_{\mathrm{C}}=4.5 \mathrm{Adc}, \mathrm{I}_{\mathrm{B} 1}=0.9 \mathrm{Adc},\right. \\ \left.\mathrm{I}_{\mathrm{B} 2}=2.25 \mathrm{Adc}\right) \end{gathered}$ | ( $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ ) | $\mathrm{t}_{\mathrm{fi}}$ | - | $\begin{gathered} \hline 85 \\ 135 \end{gathered}$ | $150$ | ns |
| Storage Time |  | ( $\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}$ ) | $\mathrm{t}_{\mathrm{si}}$ | - | 2.0 2.6 | 3.2 <br> - | $\mu \mathrm{S}$ |
| Crossover Time |  | $\left(\mathrm{T}_{\mathrm{C}}=125^{\circ} \mathrm{C}\right)$ | $\mathrm{t}_{\mathrm{c}}$ | - | 210 250 | 300 - | ns |

[^1]
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TYPICAL STATIC CHARACTERISTICS

$\mathrm{I}_{\mathrm{C}}$, COLLECTOR CURRENT (AMPS)
Figure 1. DC Current Gain @ 1 Volt


Figure 3. Collector Saturation Region


Figure 2. DC Current Gain @ 5 Volts

Figure 4. Collector-Emitter Saturation Voltage


Figure 5. Base-Emitter Saturation Region


Figure 6. Capacitance

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TYPICAL SWITCHING CHARACTERISTICS
( $\mathrm{I}_{\mathrm{B} 2}=\mathrm{I}_{\mathrm{C}} / 2$ for all switching)


Figure 7. Resistive Switching, $\mathrm{t}_{\mathrm{on}}$


Figure 9. Inductive Storage Time, $\mathbf{t}_{\mathbf{s i}}$


Figure 11. Inductive Switching, $\mathrm{t}_{\mathrm{c}}$ and $\mathrm{t}_{\mathrm{fi}}$ $I_{C} / I_{B}=5$


Figure 8. Resistive Switching, $\mathrm{t}_{\text {off }}$


Figure 10. Inductive Storage Time, $\mathrm{t}_{\mathbf{s i}}\left(\mathrm{h}_{\mathrm{FE}}\right)$

$I_{C}$, COLLECTOR CURRENT (AMPS)
Figure 12. Inductive Switching, $\mathrm{t}_{\mathrm{c}}$ and $\mathrm{t}_{\mathrm{fi}}$ $\mathrm{I}_{\mathrm{C}} / \mathrm{I}_{\mathrm{B}}=10$


Figure 13. Inductive Fall Time


Figure 14. Inductive Crossover Time

## GUARANTEED SAFE OPERATING AREA INFORMATION



Figure 15. Forward Bias Safe Operating Area


Figure 17. Forward Bias Power Derating
There are two limitations on the power handling ability of a transistor: average junction temperature and second breakdown. Safe operating area curves indicate $I_{C}-V_{C E}$


Figure 16. Reverse Bias Switching Safe Operating Area
limits of the transistor that must be observed for reliable operation; i.e., the transistor must not be subjected to greater dissipation than the curves indicate. The data of Figure 15 is based on $\mathrm{T}_{\mathrm{C}}=25^{\circ} \mathrm{C} ; \mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ is variable depending on power level. Second breakdown pulse limits are valid for duty cycles to $10 \%$ but must be derated when $\mathrm{T}_{\mathrm{C}}>25^{\circ} \mathrm{C}$. Second breakdown limitations do not derate the same as thermal limitations. Allowable current at the voltages shown in Figure 15 may be found at any case temperature by using the appropriate curve on Figure 17. $\mathrm{T}_{\mathrm{J}(\mathrm{pk})}$ may be calculated from the data in Figure 20 and 21. At any case temperatures, thermal limitations will reduce the power that can be handled to values less than the limitations imposed by second breakdown. For inductive loads, high voltage and current must be sustained simultaneously during turn-off with the base-to-emitter junction reverse-biased. The safe level is specified as a reverse-biased safe operating area (Figure 16). This rating is verified under clamped conditions so that the device is never subjected to an avalanche mode.

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Figure 18. Dynamic Saturation Voltage Measurements


Figure 19. Inductive Switching Measurements


Table 1. Inductive Load Switching Drive Circuit

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## TYPICAL THERMAL RESPONSE



Figure 20. Typical Thermal Response ( $\mathrm{Z}_{\theta \mathrm{JC}}(\mathrm{t})$ ) for MJE18008


Figure 21. Typical Thermal Response ( $\mathrm{Z}_{\theta \mathrm{Jc}}(\mathrm{t})$ ) for MJF18008

ORDERING INFORMATION

| Device | Package | Shipping |
| :--- | :---: | :---: |
| MJE18008G | TO-220AB <br> (Pb-Free) | 50 Units / Rail |
| MJF18008G | TO-220 (Fullpack) <br> (Pb-Free) | 50 Units / Rail |

## TEST CONDITIONS FOR ISOLATION TESTS*



Figure 22a. Screw or Clip Mounting Position for Isolation Test Number 1

Figure 22b. Clip Mounting Position for Isolation Test Number 2
*Measurement made between leads and heatsink with all leads shorted together

## MOUNTING INFORMATION**



Figure 23a. Screw-Mounted


Figure 23b. Clip-Mounted

Figure 23. Typical Mounting Techniques

## for Isolated Package

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to $8 \mathrm{in} \cdot \mathrm{lbs}$ is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of $20 \mathrm{in} \cdot \mathrm{lbs}$ will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted $4-40$ screws indicate that the screw slot fails between 15 to 20 in $\cdot \mathrm{lbs}$ without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding $10 \mathrm{in} \cdot \mathrm{lbs}$ of mounting torque under any mounting conditions.

[^2]
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## PACKAGE DIMENSIONS

TO-220
CASE 221A-09
ISSUE AH


TO-220 FULLPAK
CASE 221D-03
ISSUE K


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
. CONTROLLING DIMENSION: INCH
2. 221D-01 THRU 221D-02 OBSOLETE, NEW STANDARD 221D-03.

|  | INCHES |  | MILLIMETERS |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| DIM | MIN | MAX | MIN | MAX |  |  |
| A | 0.617 | 0.635 | 15.67 | 16.12 |  |  |
| B | 0.392 | 0.419 | 9.96 | 10.63 |  |  |
| C | 0.177 | 0.193 | 4.50 | 4.90 |  |  |
| D | 0.024 | 0.039 | 0.60 | 1.00 |  |  |
| F | 0.116 | 0.129 | 2.95 |  |  |  |
| G | 0.100 |  | BSC | 2.54 |  | BSC |
| H | 0.118 | 0.135 | 3.00 |  |  |  |
| J | 0.018 | 0.025 | 0.43 |  |  |  |
| K | 0.503 | 0.541 | 12.78 | 0.63 |  |  |
| L | 0.048 | 0.058 | 1.23 |  |  |  |
| N | 0.200 |  | BSC | 5.08 |  | BSC |
| Q | 0.122 | 0.138 | 3.10 |  |  |  |
| R | 0.099 | 0.117 | 3.50 |  |  |  |
| S | 0.092 | 0.113 | 2.51 | 2.96 |  |  |
| U | 0.239 | 0.271 | 2.34 |  |  |  |

STYLE 2:
PIN 1. BASE
. COLLECTOR
. EMITTER

## MJE18008, MJF18008

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[^1]:    3. Pulse Test: Pulse Width $=5.0 \mathrm{~ms}$, Duty Cycle $\leq 10 \%$.
    4. Proper strike and creepage distance must be provided.
[^2]:    ** For more information about mounting power semiconductors see Application Note AN1040.

